

## SANYO Semiconductors DATA SHEET

N-Channel Silicon MOSFET

# **6LN04MH** — General-Purpose Switching Device **Applications**

#### **Features**

• 1.5V drive.

#### **Specifications**

#### Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	VDSS		60	V
Gate-to-Source Voltage	VGSS		±10	V
Drain Current (DC)	ΙD		200	mA
Drain Current (Pulse)	IDP	PW≤10μs, duty cycle≤1%	800	mA
Allowable Power Dissipation	PD	Mounted on a ceramic board (900mm²X0.8mm)	0.6	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C

#### Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions	Ratings			
			min	typ	max	Unit
Drain-to-Source Breakdown Voltage	V(BR)DSS	ID=1mA, VGS=0V	60			V
Zero-Gate Voltage Drain Current	IDSS	V <sub>DS</sub> =60V, V <sub>GS</sub> =0V			1	μΑ
Gate-to-Source Leakage Current	IGSS	V <sub>GS</sub> =±8V, V <sub>DS</sub> =0V			±10	μΑ
Cutoff Voltage	VGS(off)	V <sub>DS</sub> =10V, I <sub>D</sub> =100μA	0.4		1.3	V
Forward Transfer Admittance	yfs	V <sub>DS</sub> =10V, I <sub>D</sub> =100mA	280	480		mS
Static Drain-to-Source On-State Resistance	R <sub>DS</sub> (on)1	ID=100mA, VGS=4V		2.2	2.9	Ω
	RDS(on)2	ID=50mA, VGS=2.5V		2.4	3.4	Ω
	R <sub>DS</sub> (on)3	I <sub>D</sub> =10mA, V <sub>GS</sub> =1.5V		3.5	7.0	Ω
Input Capacitance	Ciss	V <sub>DS</sub> =20V, f=1MHz		26		pF
Output Capacitance	Coss	V <sub>DS</sub> =20V, f=1MHz		5.9		pF
Reverse Transfer Capacitance	Crss	V <sub>DS</sub> =20V, f=1MHz		3.2		pF
Turn-ON Delay Time	t <sub>d</sub> (on)	See specified Test Circuit.		18.5		ns
Rise Time	tr	See specified Test Circuit.		26		ns
Turn-OFF Delay Time	t <sub>d</sub> (off)	See specified Test Circuit.		146		ns
Fall Time	tf	See specified Test Circuit.		69		ns

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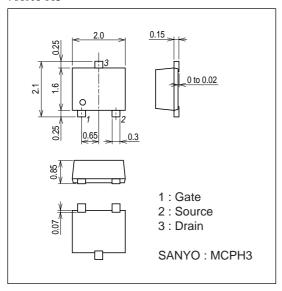
#### 6LN04MH

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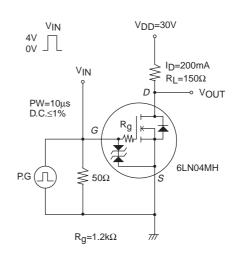
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Offic
Total Gate Charge	Qg	VDS=30V, VGS=4V, ID=200mA		1.0		nC
Gate-to-Source Charge	Qgs	V <sub>DS</sub> =30V, V <sub>GS</sub> =4V, I <sub>D</sub> =200mA		0.2		nC
Gate-to-Drain "Miller" Charge	Qgd	VDS=30V, VGS=4V, ID=200mA		0.2		nC
Diode Forward Voltage	VsD	IS=200mA, VGS=0V		0.83	1.2	V

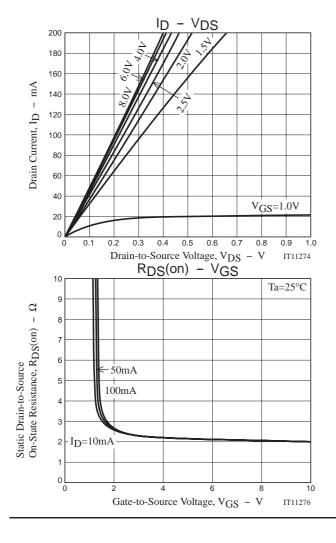
#### **Package Dimensions**

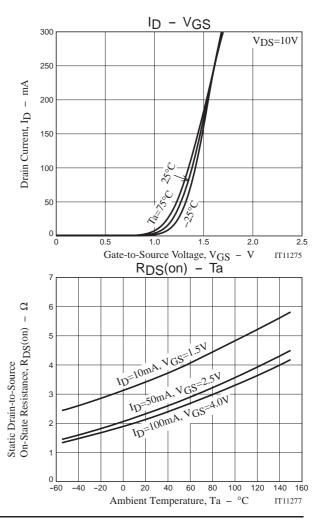
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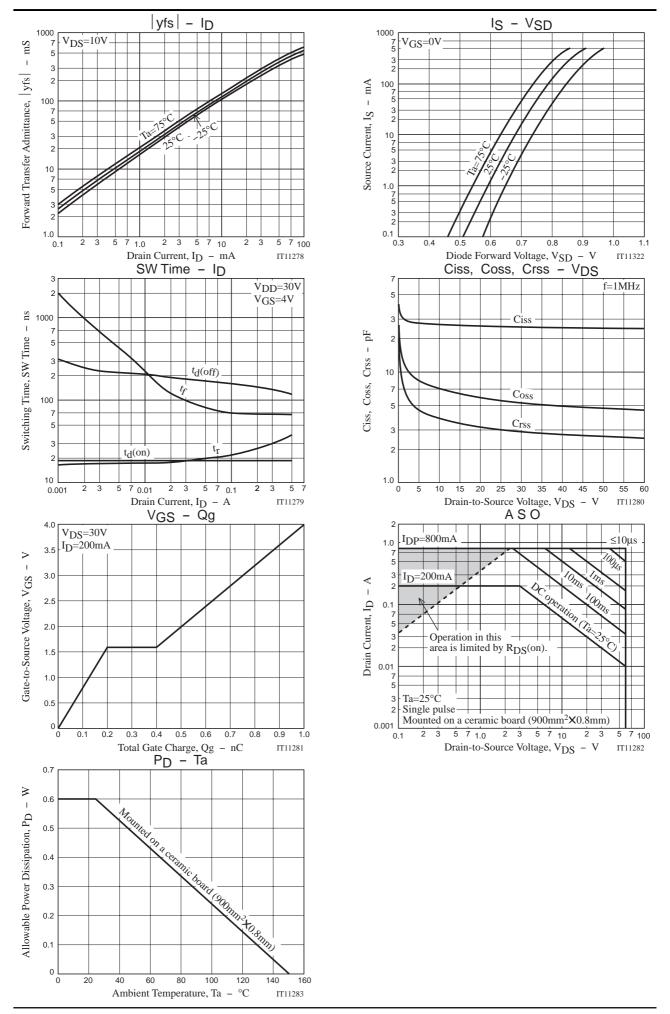


### **Switching Time Test Circuit**









Note on usage: Since the 6LN04MH is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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